

METHOD FOR MANUFACTURING LIGHT EMITTING DIODE DEVICES

Abstract of the Disclosure

A plurality of LEDs are mounted on a substrate
5 aggregation, a transparent layer is formed on the substrate
aggregation. The transparent layer between adjacent
divisions is removed to form an individual transparent layer
and to form a groove around the individual transparent layer.
The groove is filled with a reflector material to form a
10 reflector layer. The reflector layer and the substrate are
cut so as to form a reflector film on the outside wall of
the individual transparent layer, thereby forming a plurality
of LED devices.